



Winstar Display Co., LTD

華凌光電股份有限公司



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SPECIFICATION

CUSTOMER : _____

MODULE NO.: WF43MTIBEDRGB#

<p>APPROVED BY: (FOR CUSTOMER USE ONLY)</p>	<p>PCB VERSION: _____ DATA: _____</p>
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SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
			葉虹蘭
ISSUED DATE: 2017/02/08			

RECORDS OF REVISION			DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2016/10/12		First issue
A	2016/11/01		Modify Touch Panel Information.
B	2017/02/08		Modify CTP Interface.

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13.Contour Drawing

14.Other

1.Module Classification Information

W F 43 M T I B E D R G B #
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬

①	Brand : WINSTAR DISPLAY CORPORATION			
②	Display Type : F→TFT Type, J→Custom TFT			
③	Display Size : 4.3" TFT			
④	Model serials no.			
⑤	Backlight Type :	T→LED, White S→LED, High Light White		
⑥	LCD Polarize Type/ Temperature range/ Gray Scale Inversion Direction	I→Transmissive, W. T, 6:00 L→Transmissive, W.T,12:00 Z→Transmissive, W.T, O-TFT		
⑦	B : TFT+FR+CONTROL BOARD			
⑧	Resolution:	C:320240	E:480272	G: 800480
⑨	TFT type D: Digital panel			
⑩	Interface : R: Uart S: SPI-4 (preservation)			
⑪	TS : N : Without TS T : RTP (preservation)			
⑫	Version			
⑬	Special Code	#:Fit in with ROHS directive regulations		

2.Summary

TFT 4.3” is a TN transmissive type color active matrix TFT liquid crystal display that use amorphous silicon TFT as switching devices. This module is a composed of a TFT_LCD module, It is usually designed for indusrial application and this module follows RoHs,

3. General Specifications

Item	Dimension	Unit
Size	4.3	inch
Dot Matrix	480 x RGBx272(TFT)	dots
Module dimension	125.5(W) x 67.2(H) x 9.25 (D)	mm
Active area	95.04 x 53.856	mm
Dot pitch	0.066 x 0.198	mm
LCD type	TFT, Normally White, Transmissive	
View Direction	12 o'clock	
Gray Scale Inversion Direction	6 o'clock	
Aspect Ratio	16:9	
Backlight Type	LED, Normally White	
Interface	Uart 19200 Baud rate/SPI	
CTP FW Version	8	
With /Without TP	With CTP	
Surface	Glare	

*Color tone slight changed by temperature and driving voltage

4. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	TOP	-20	—	+70	°C
Storage Temperature	TST	-30	—	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp. $\leq 60^{\circ}\text{C}$, 90% RH MAX. Temp. $> 60^{\circ}\text{C}$, Absolute humidity shall be less than 90% RH at 60°C

5. Electrical Characteristics

5.1. Operating conditions:

Item	Symbol	Condition	Min	Typ	Max	Unit	Remark
Supply Voltage For LCM	VBUS	—	4.5	5	5.5	V	—
Supply Current For LCM	IBUS	—	—	220	240	mA	Note1
Power Consumption	—	VBUS=5V	—	1100	1320	mW	VBUS=5V Note 2

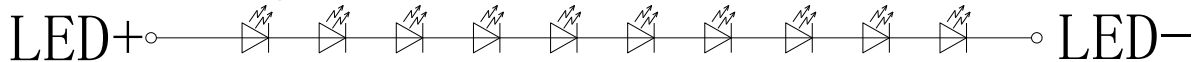
Note 1 : This value is test for VBUS=5V , Ta=25 °C only

Note 2 : Power consumption is include Backlight driver system

5.2. LED driving conditions (LED Driver system build in)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED current	-	-	20	-	mA	-
Power Consumption	-	-	640	680	mW	-
LED voltage	VBL+	30	32	34	V	Note 1
LED Life Time	-	-	50,000	-	Hr	Note 2,3,4

Note 1 : There are 1 Groups LED



Note 2 : Ta = 25 °C

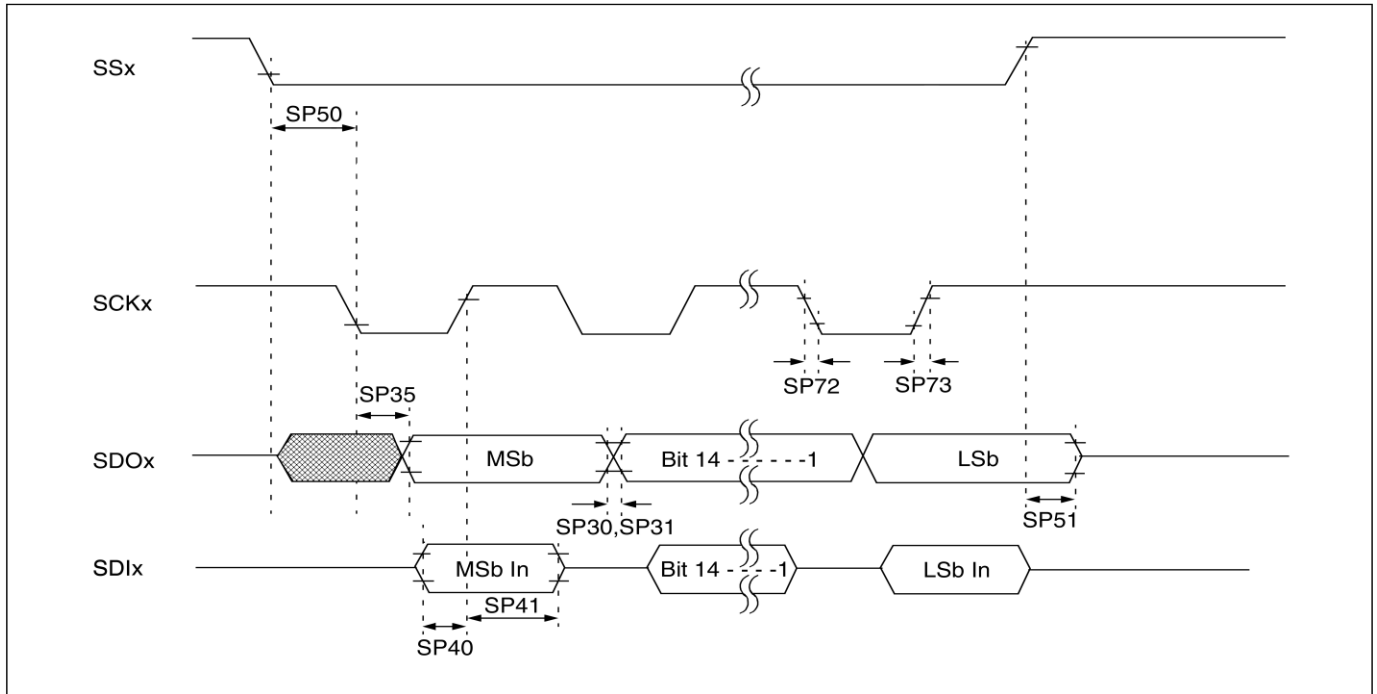
Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case

6.DC CHARATERISTICS

Parameter	Symbol	Rating			Unit	Condition
		Min	Typ	Max		
Low level input voltage	V_{IL}	0	-	0.3VBUS	V	
High level input voltage	V_{IH}	0.7VBUS	-	VBUS	V	

7.SPI Timing Characteristics



AC CHARACTERISTICS							
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions
SP70	TscL	SCKx Input Low Time	250	—	—	ns	
SP71	TschH	SCKx Input High Time	250	—	—	ns	
SP72	TscF	SCKx Input Fall Time ⁽²⁾	—	10	25	ns	
SP73	TscR	SCKx Input Rise Time ⁽²⁾	—	10	25	ns	
SP30	TdoF	SDOx Data Output Fall Time ⁽²⁾	—	10	25	ns	
SP31	TdoR	SDOx Data Output Rise Time ⁽²⁾	—	10	25	ns	
SP35	Tsch2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	—	30	ns	
SP40	TdiV2sch, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	20	—	—	ns	
SP41	Tsch2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	20	—	—	ns	
SP50	Tssl2sch, Tssl2scL	\overline{SSx} to SCKx \uparrow or SCKx Input	120	—	—	ns	
SP51	Tssh2doZ	\overline{SSx} \uparrow to SDOx Output High-Impedance ⁽³⁾	10	—	50	ns	
SP52	Tsch2ssH TscL2ssH	\overline{SSx} after SCKx Edge	50	—	—	ns	

8. Instructions Table

8.1. UART Mode

Text Mode

Instruction of text mode

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21
SB 1	PL	SB 2	SB 3	M D	W R	TR	X H	XL	Y H	YL	S R	S G	SB	B R	B G	B B	TA SDA	EB 1	EB 2	EB 3

Graphic Mode

Instruction of Graphic mode:

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
SB1	PL	SB2	SB3	MD	RR	XH	XL	YH	YL	PH	PL	EB1	EB2	EB3	SB1

Pixel Mode

Instruction of Pixel mode

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
SB1	PL	SB2	SB3	MD	RR	XH	XL	YH	YL	PR	PG	PB	EB1	EB2	EB3

Geometry Mode

Instruction of geometry mode

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21
SB 1	PL	SB 2	SB 3	M D	R R	XS H	XS L	YS H	YS L	XE H	XE L	YE H	YE L	LS	LR	LG	LB	EB 1	EB 2	EB 3

Clean Mode

Instruction of Clean Mode

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
SB1	PL	SB 2	SB 3	MD	XSH	XSL	YSH	YSL	XEH	XEL	YEH	YEL	EB1	EB2	EB3

PWM Mode

Instruction of Pixel mode

1	2	3	4	5	6	7	8	9	10	11	12	13
SB1	PL	SB2	SB3	MD	PS	PFH	PFL	PDH	PDL	EB1	EB2	EB3

Backlight Mode

Instruction of Clean Mode

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
SB1	PL	SB2	SB3	MD	RR	XH	XL	YH	YL	PR	PG	PB	EB1	EB2	EB3

8.2. SPI Mode

Text Mode

Instruction of text mode

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
0x31	SB ₃	MD	WR	TR	XH	XL	YH	YL	SR	SG	SB	BR	BG	B B	TA SDA

Graphic Mode

Instruction of Graphic mode:

1	2	3	4	5	6	7	8	9	10
0x31	SB3	MD	RR	XH	XL	YH	YL	PH	PL

Pixel Mode

Instruction of Pixel mode

1	2	3	4	5	6	7	8	9	10	11
0x31	SB3	MD	RR	XH	XL	YH	YL	PR	PG	PB

Geometry Mode

Instruction of geometry mode

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
0x31	SB ₃	MD	RR	XS H	XSL	YS H	YSL	XE H	XEL	YE H	YEL	LS	LR	LG	LB

Clean Mode

Instruction of Clean Mode

1	2	3	4	5	6	7	8	9	10	11
0x31	SB3	MD	XSH	XSL	YSH	YSL	XEH	XEL	YEH	YEL

PWM Mode

Instruction of Pixel mode

1	2	3	4	5	6	7	8
0x31	SB3	MD	PS	PFH	PFL	PDH	PDL

Backlight Mode

Instruction of Clean Mode

1	2	3	4	5	6	7	8	9	10	11
0x31	SB3	MD	RR	XH	XL	YH	YL	PR	PG	PB

9. Optical Characteristics

Item	Symbol	Condition.	Min	Typ.	Max.	Unit	Remark
Response time	Tr+ Tf	$\theta = 0^\circ$ 、 $\Phi = 0^\circ$	-	30	45	.ms	Note 3
Contrast ratio	CR	At optimized viewing angle	250	350	-	-	Note 4
Color Chromaticity	White	W_x	0.28	0.30	0.33		Note 2,5
		W_y	0.31	0.33	0.36		
Viewing angle	Hor.	Θ_R	55	65	-	Deg.	Note 1
		Θ_L	55	65	-		
	Ver.	Φ_T	45	55	-		
		Φ_B	45	55	-		
Brightness	-	-	320	400	-	cd/m ²	Center of display

Ta=25±2°C

Note 1: Definition of viewing angle range

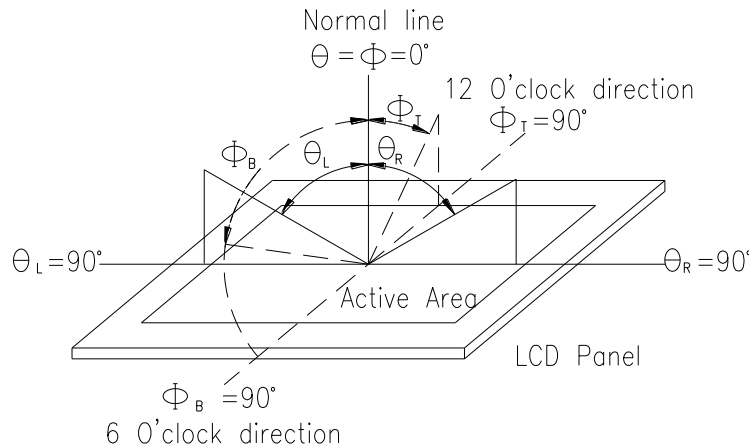


Fig. 9.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7 or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

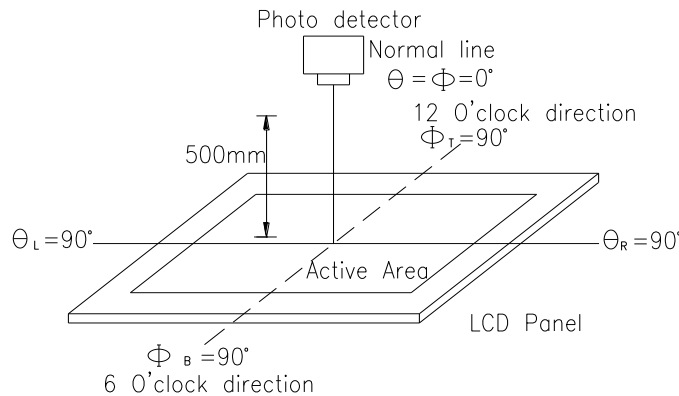
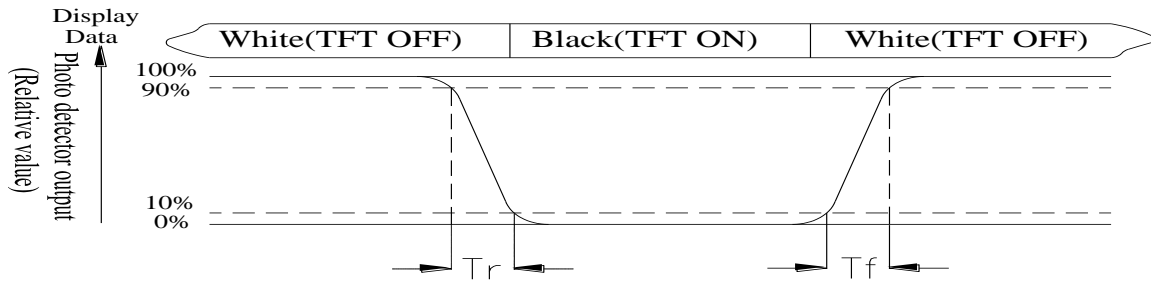


Fig. 9.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time, Tr, is the time between photo detector output intensity changed from 90% to

10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: White $V_i = V_{i50} \pm 1.5V$

Black $V_i = V_{i50} \pm 2.0V$

“±” means that the analog input signal swings in phase with VCOM signal.

“±” means that the analog input signal swings out of phase with VCOM signal.

The 100% transmission is defined as the transmission of LCD panel when all the input terminals of module are electrically opened.

Note 6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

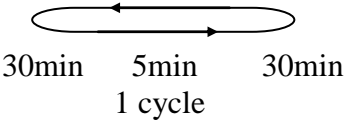
10.Interface

CON 2			
Pin	Symbol	I/O	Function
1	GND	Power Supply	Power Ground
2	TX	O	Uart Transmit pin
3	RX	I	Uart Receive pin
4	VBUS	Power Supply	Power supply : 5V
5	D+	I/O	USB Data +
6	D-	I/O	USB Data -
7	GND	Power Supply	Power Ground
8	/REST	I	Reset (active Low)
9	GND	Power Supply	Power Ground
10	PWM	O	Pulse width modulation
11	GND	Power Supply	Power Ground
12	VBUS	Power Supply	Power supply : 5V

CON 3			
Pin	Symbol	I/O	Function
1	GND	Power Supply	Power Ground
2	SW1	I	Switch (active low)
3	SW2	I	Switch (active low)
4	SW3	I	Switch (active low)
5	SW4	I	Switch (active low)
6	GND	Power Supply	Power Ground
7	SDI	O	Master Input Slave Output (MISO)
8	SDO	I	Master Output Slave Input (MOSI)
9	SCK	I	Serial Clock
10	CS	I	Serial Chip selection
11	SPI_INT	O	Serial Interrupt
12	VBUS	Power Supply	Power supply : 5V

11. Reliability

Content of Reliability Test (Wide temperature, -20°C ~70°C)

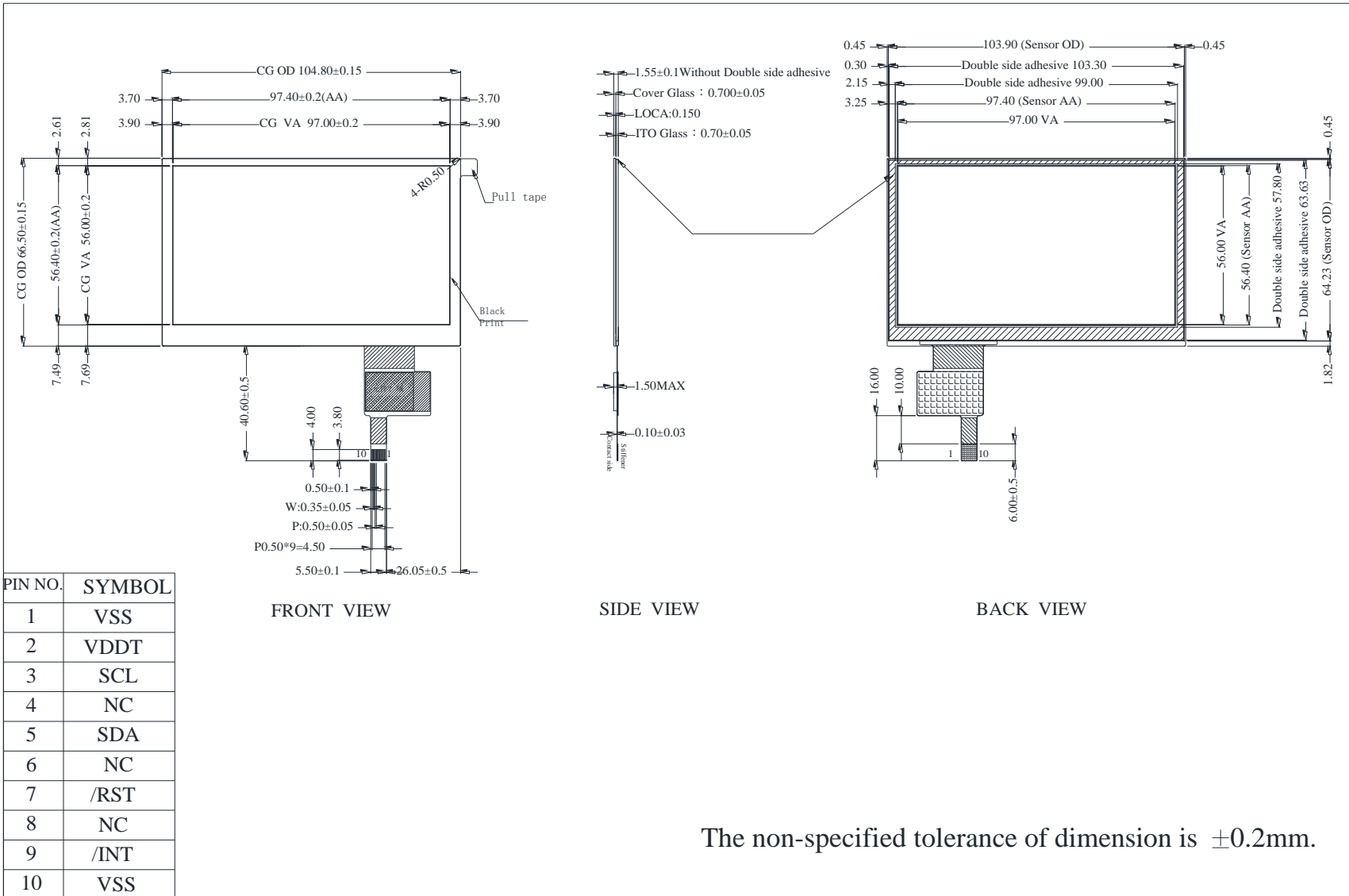
Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 °C, 90%RH max	60°C, 90%RH 96hrs	1,2
Thermal shock resistance	<p>The sample should be allowed stand the following 10 cycles of operation</p> <p style="text-align: center;">-20°C 25°C 70°C</p>  <p style="text-align: center;">30min 5min 30min 1 cycle</p>	-20°C /70°C 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	—

Note1: No dew condensation to be observed.

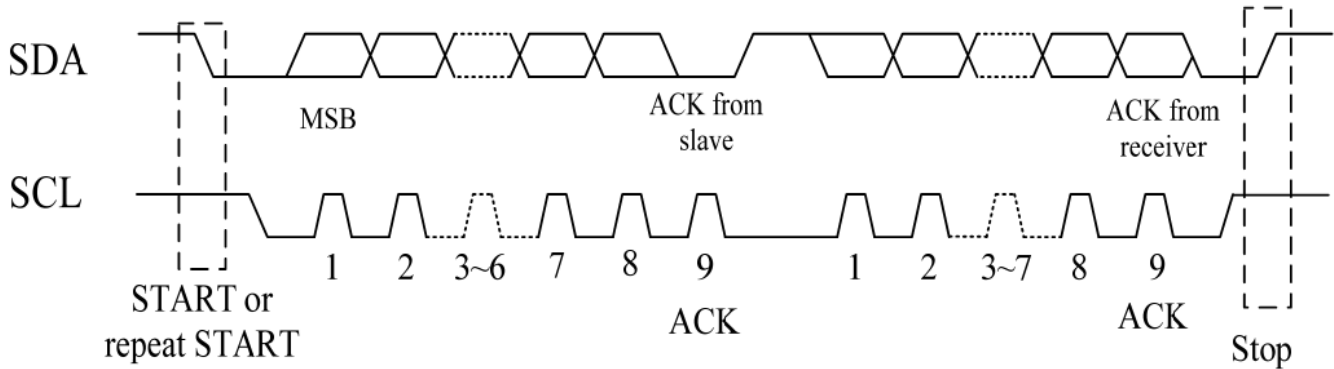
Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

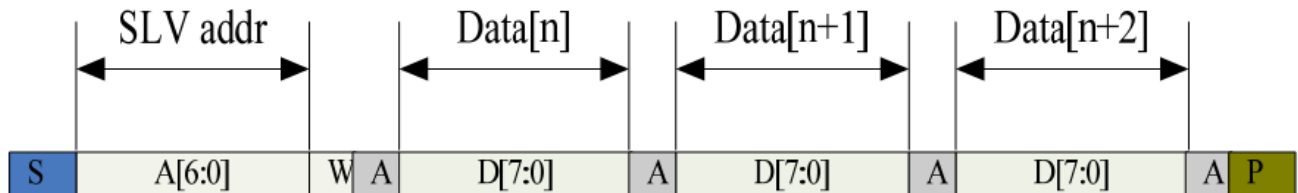
12.Touch Panel Information



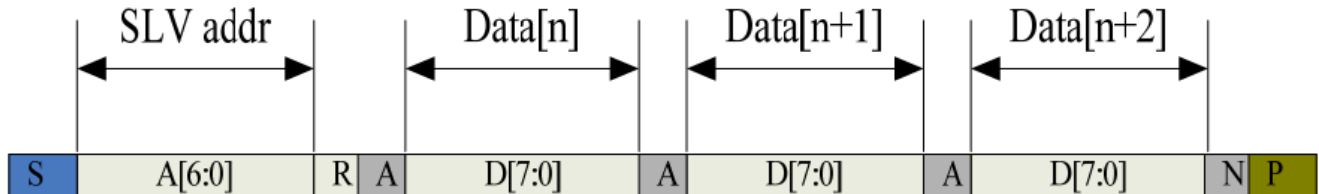
12.1. CTP I2C Timing:



I2C Serial Data Transfer Format



I2C master write, slave read



I2C master read, slave write

Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address
R/W	READ/WRITE bit, '1' for read, '0' for write
A(N)	ACK(NACK) bit
P	STOP: the indication of the end of a packet(if this bit is missing, S will indicate the end of the current packet and beginning of the next packet)

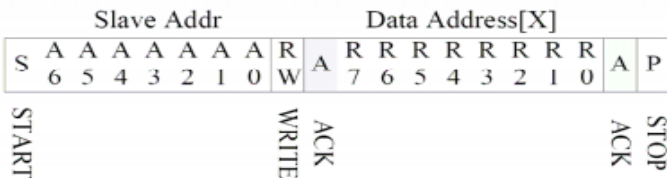
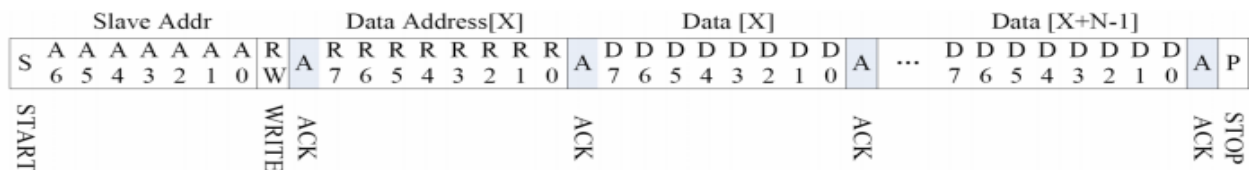
Lists the meanings of the mnemonics used in the above figures

Parameter	Unit	Min	Max
SCL frequency	KHz	0	400
Bus free time between a STOP and START condition	us	4.7	\
Hold time (repeated) START condition	us	4.0	\
Data setup time	ns	250	\
Setup time for a repeated START condition	us	4.7	\
Setup time for STOP condition	us	4.0	\

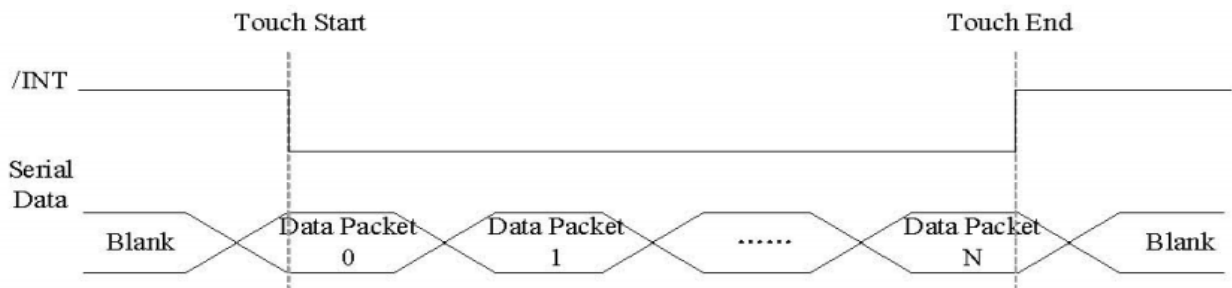
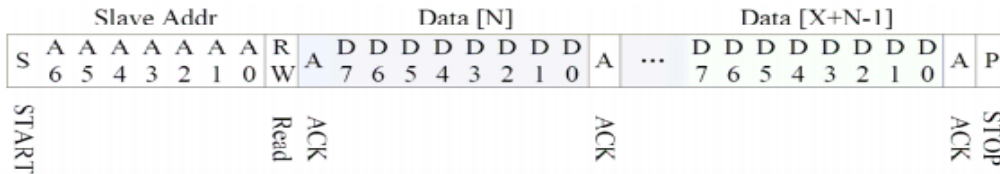
Interface Timing Characteristics

AS FOR STANDARD CTPM, HOST NEED TO USE BOTH INTERRUPT CONTROL SIGNAL AND SERIAL DATA INTERFACE TO GET THE TOUCH DATA. HERE IS THE TIMING TO GET TOUCH DATA.

12.2. WRITE BYTES TO I2C SLAVE



READ X BYTES FROM I2C SLAVE



Address: 0x38

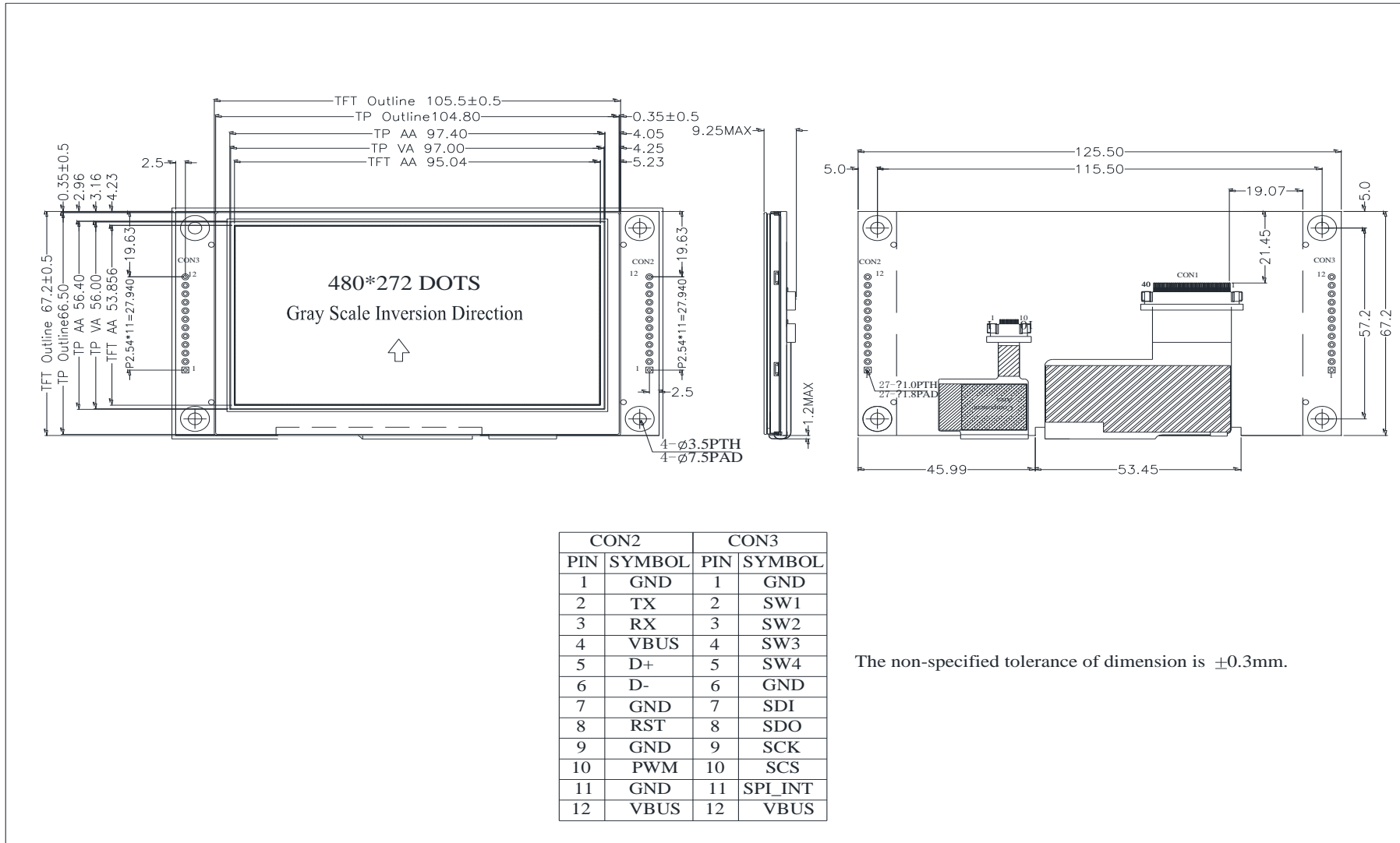
12.3. TOUCH DATA READ PROTOCOL

NAME	VALUE	DESCRIPTION
START CH	0X00	START COMMAND FOR CTPM TOUCH DATA PACKET,HOST MUST SEND CTPM A START CH COMMAND BEFORE READ TOUCH DATA
Lst READ BYTE~ LAST READ BYTE		TOUCH DATA PACKET SENT BY CTPM,EACH BYTE HAS 8-BIT DATA ,A TOUCH DATA PACKET CONSISTS OF N BYTE

Address	Name	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Host Access
00h	Devide__Mode		Device Model[2:0]							RW
01h	Gest__ID	Gesture ID[7:0]								R
02h	TD__Status					Number of touch points[3:0]				R
03h	Touch1__XH	1 st Event Flag				1 st Touch X Position[11:8]				R
04h	Touch1__XL	1 st Touch X Position[7:0]								R
05h	Touch1__YH	1 st Touch ID[3:0]				1 st Touch Y Position[11:8]				R
06h	Touch1__YL	1 st Touch Y Position[7:0]								R
07h										R
08h										R
09h	Touch2__XH	2 nd Event Flag				2 nd Touch X Position[11:8]				R
0Ah	Touch2__XL	2 nd Touch X Position[7:0]								R
0Bh	Touch2__YH	2 nd Touch ID[3:0]				2ndTouch Y Position[11:8]				R
0Ch	Touch2__YL	2 nd Touch Y Position[7:0]								R
0Dh										R
0Eh										R
0Fh	Touch3__XH	3rdEvent Flag				3rdTouch X Position[11:8]				R
10h	Touch3__XL	3rd Touch X Position[7:0]								R

11h	Touch3__YH	3rdTouch ID[3:0]	3rdTouch Y Position[11:8]	R
12h	Touch3__YL	3rd Touch Y Position[7:0]		R
13h				R
14h				R
15h	Touch4__XH	4thEvent Flag	4thTouch X Position[11:8]	R
16h	Touch4__XL	4th Touch X Position[7:0]		R
17h	Touch4__YH	4thTouch ID[3:0]	4thTouch Y Position[11:8]	R
18h	Touch4__YL	4th Touch Y Position[7:0]		R
19h				R
1Ah				R
1Bh	Touch5__XH	5thEvent Flag	5thTouch X Position[11:8]	R
1Ch	Touch5__XL	5th Touch X Position[7:0]		R
1Dh	Touch5__YH	5thTouch ID[3:0]	5thTouch Y Position[11:8]	R
1Eh	Touch5__YL	5th Touch Y Position[7:0]		R

13. Contour Drawing





1、Panel Specification :

- 1. Panel Type : Pass NG , _____
- 2. View Direction : Pass NG , _____
- 3. Numbers of Dots : Pass NG , _____
- 4. View Area : Pass NG , _____
- 5. Active Area : Pass NG , _____
- 6. Operating Temperature : Pass NG , _____
- 7. Storage Temperature : Pass NG , _____
- 8. Others : _____

2、Mechanical Specification :

- 1. PCB Size : Pass NG , _____
- 2. Frame Size : Pass NG , _____
- 3. Material of Frame : Pass NG , _____
- 4. Connector Position : Pass NG , _____
- 5. Fix Hole Position : Pass NG , _____
- 6. Backlight Position : Pass NG , _____
- 7. Thickness of PCB : Pass NG , _____
- 8. Height of Frame to PCB : Pass NG , _____
- 9. Height of Module : Pass NG , _____
- 10. Others : Pass NG , _____

3、Relative Hole Size :

- 1. Pitch of Connector : Pass NG , _____
- 2. Hole size of Connector : Pass NG , _____
- 3. Mounting Hole size : Pass NG , _____
- 4. Mounting Hole Type : Pass NG , _____
- 5. Others : Pass NG , _____

4、Backlight Specification :

- 1. B/L Type : Pass NG , _____
- 2. B/L Color : Pass NG , _____
- 3. B/L Driving Voltage (Reference for LED Type) : Pass NG , _____
- 4. B/L Driving Current : Pass NG , _____
- 5. Brightness of B/L : Pass NG , _____
- 6. B/L Solder Method : Pass NG , _____
- 7. Others : Pass NG , _____

>> **Go to page 2** <<



Winstar Module Number : _____

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5、Electronic Characteristics of Module :

- 1. Input Voltage : Pass NG , _____
- 2. Supply Current : Pass NG , _____
- 3. Driving Voltage for LCD : Pass NG , _____
- 4. Contrast for LCD : Pass NG , _____
- 5. B/L Driving Method : Pass NG , _____
- 6. Negative Voltage Output : Pass NG , _____
- 7. Interface Function : Pass NG , _____
- 8. LCD Uniformity : Pass NG , _____
- 9. ESD test : Pass NG , _____
- 10. Others : Pass NG , _____

6、Summary :

Sales signature : _____

Customer Signature : _____

Date : / / _____